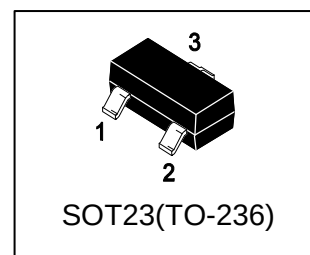


LBSS123LT1G

N-CHANNEL POWER MOSFET

1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.

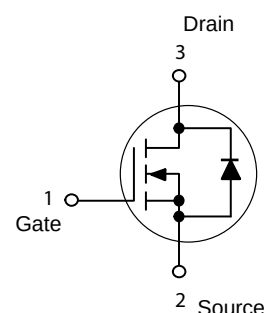


2. DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LBSS123LT1G	SA	3000/Tape&Reel
LBSS123LT3G	SA	13000/Tape&Reel

3. MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
Drain–Source Voltage	VDSS	100	V
Gate–to–Source Voltage			
– Continuous	VGS	±20	V
– Non–repetitive (tp ≤ 50 μs)	VGSM	±40	
Drain Current			A
– Continuous (Note 1)	ID	0.17	
– Pulsed (Note 2)	IDM	0.68	



4. THERMAL CHARACTERISTICS

Parameter	Symbol	Limits	Unit
Total Device Dissipation, FR-5 Board (Note 3) @ TA = 25°C	PD	225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction–to–Ambient	RθJA	556	°C/W
Junction and Storage temperature	TJ,Tstg	–55~+150	°C

1. The Power Dissipation of the package may result in a lower continuous drain current.
2. Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.
3. FR-5 = 1.0×0.75×0.062 in.

5. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

OFF CHARACTERISTICS

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain–Source Breakdown Voltage (VGS = 0, ID = 250μA)	VBRDSS	100	-	-	V
Zero Gate Voltage Drain Current (VGS = 0, VDS = 100 V, Tj=25°C) (VGS = 0, VDS = 100 V, Tj=125°C)	IDSS	-	-	1 60	μA
Gate–Body Leakage Current (VGS = ± 20 V, VDS = 0)	IGSS	-	-	± 50	nA

ON CHARACTERISTICS (Note 4)

Gate Threshold Voltage (VDS = VGS, ID = 1.0mA)	VGS(th)	0.8	-	2.0	V
Static Drain–Source On–State Resistance (VGS = 10 V, ID = 100 mA)	RDS(on)	-	5	6	Ω
Forward Transconductance (VDS = 10V, ID = 170 mA)	gfs	0.08	0.8	-	S

DYNAMIC CHARACTERISTICS

Input Capacitance (VDS = 25 V, VGS = 0, f = 1.0 MHz)	Ciss	15	42.7	88	pF
Output Capacitance (VDS = 25 V, VGS = 0, f = 1.0 MHz)	Coss	5	14	29.5	pF
Reverse Transfer Capacitance (VDS = 25 V, VGS = 0, f = 1.0 MHz)	Crss	1	3	6.3	pF
Total Gate Charge (VDS = 10 V, VGS = 10V, ID=0.22A)	Qg	2.3	6.32	13.3	nC
Gate–Source Charge (VDS = 10 V, VGS = 10V, ID=0.22A)	Qgs	0.55	1.55	3.3	nC
Gate–Drain Charge (VDS = 10 V, VGS = 10V, ID=0.22A)	Qgd	0.25	0.68	1.43	nC

SWITCHING CHARACTERISTICS (Note 4)

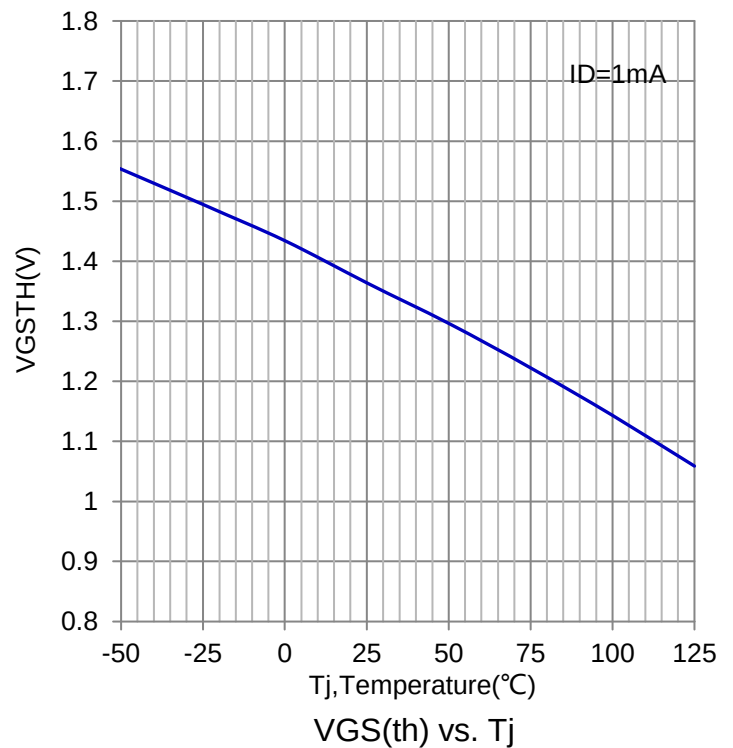
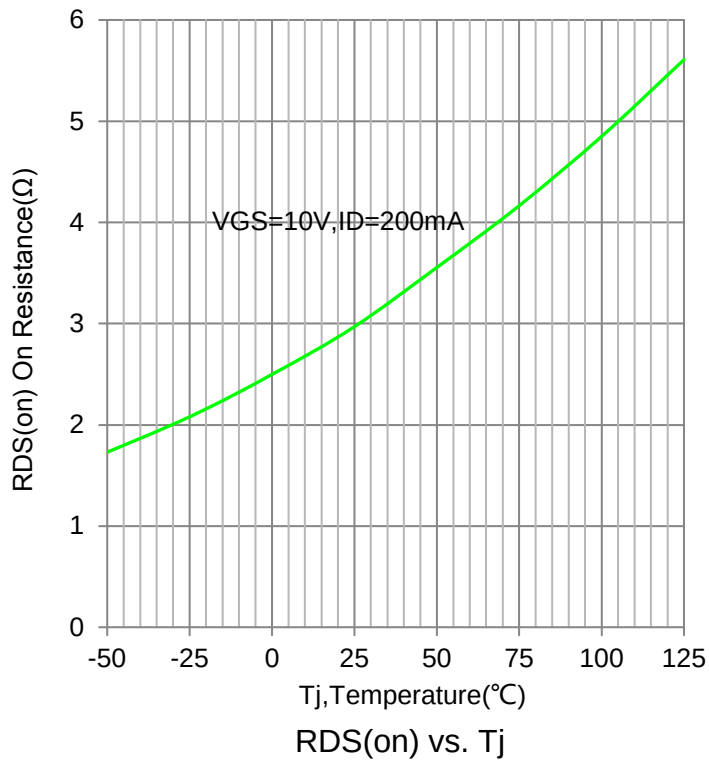
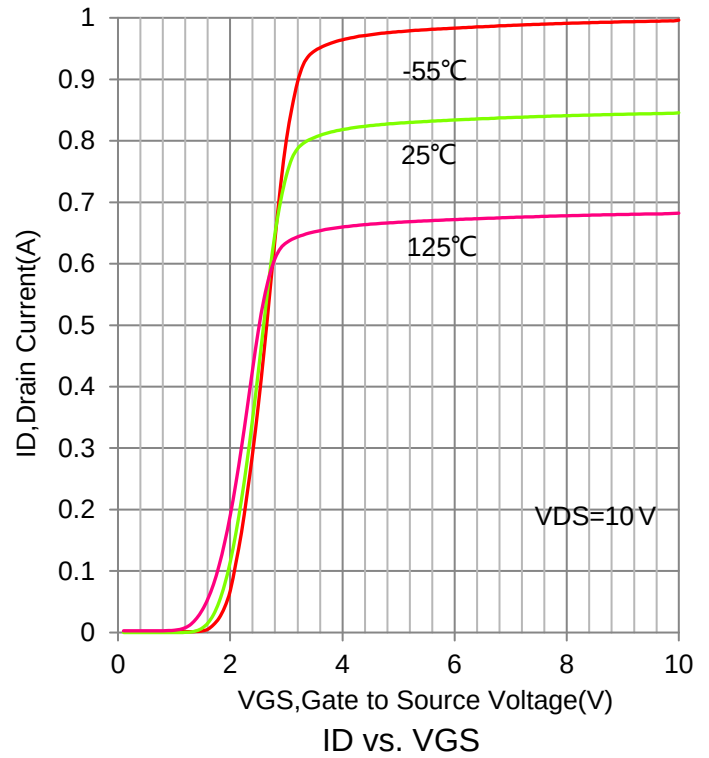
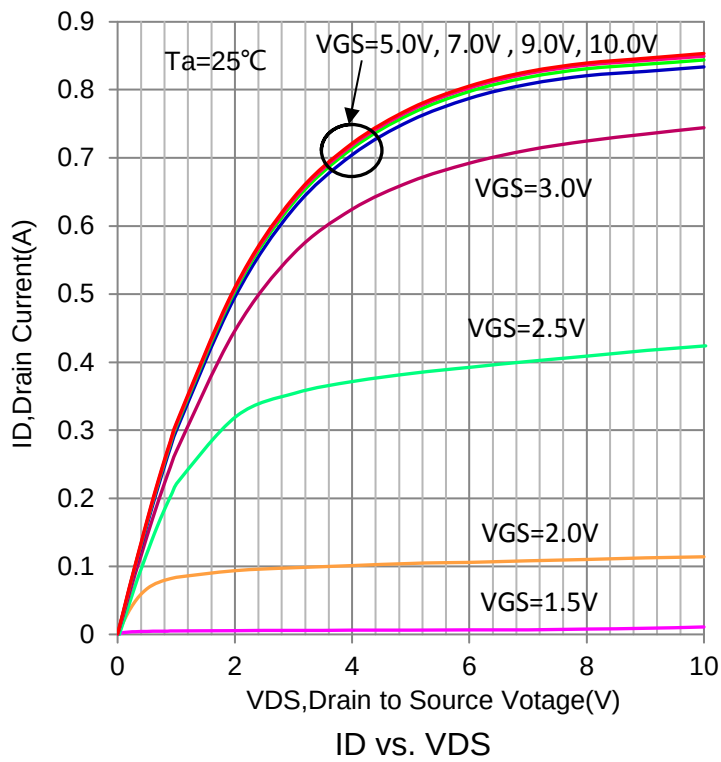
Turn-On Delay Time	(VCC = 30 V, IC = 0.28 A, VGS = 10 V, RGS = 50 Ω)	td(on)	-	20	-	ns
Turn-Off Delay Time		td(off)	-	40	-	

REVERSE DIODE

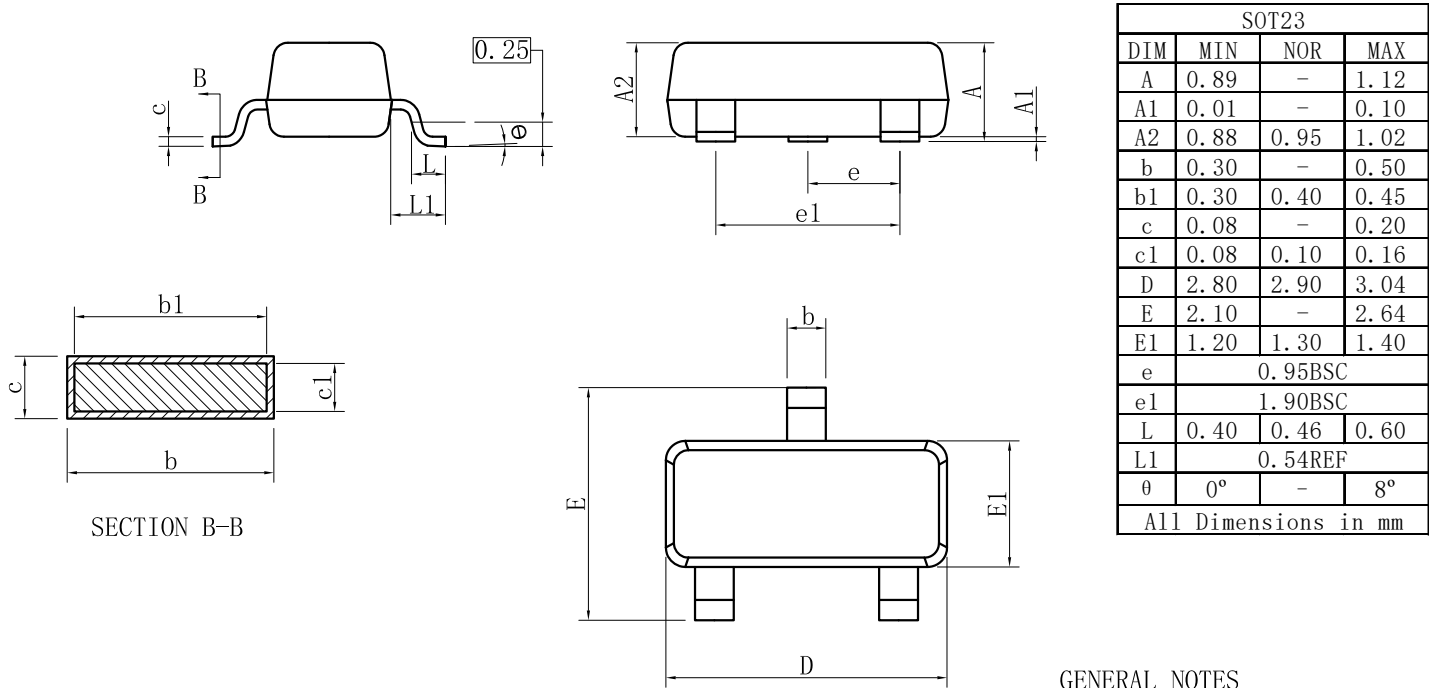
Diode Forward On–Voltage (ID = 0.34 A, VGS = 0 V)	VSD	-	-	1.3	V
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4. Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

6.ELECTRICAL CHARACTERISTICS CURVES



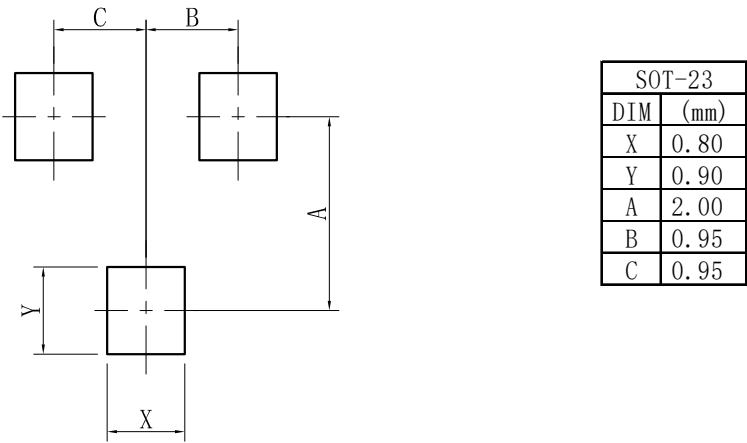
7.OUTLINE AND DIMENSIONS



GENERAL NOTES

- 1.Top package surface finish $Ra0.4\pm0.2\mu m$
- 2.Bottom package surface finish $Ra0.7\pm0.2\mu m$
- 3.Side package surface finish $Ra0.4\pm0.2\mu m$

8.SOLDERING FOOTPRINT



DISCLAIMER

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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